IN THE CLAIMS:

- 1. (Cancelled)
- 2. (Cancelled)
- 3. (Cancelled)
- 4. (Cancelled)
- 5. (Cancelled)
- 6. (Cancelled)
- 7. (Cancelled)
- 8. (Cancelled)
- 9. (Cancelled)
- 10. (Cancelled)
- 11. (Cancelled)
- 12. (Cancelled)
- 13. (Cancelled)
- 14. (Cancelled)
- 15. (New) A radiation-sensitive resin composition comprising:

water,

- a water-soluble resin dissolved in the water,
- a water-insoluble or sparingly water-soluble acid former dispersed in the water, said acid former generating an acid when irradiated with activation energy,
- a sensitizer, dispersed in the water, for sensitizing the acid generation by the acid former, and

an acid-reactive insolubilizing agent dissolved or dispersed in the water for converting the water-soluble resin into an insoluble form in the presence of said acid.

- 16. (New) The composition as recited in claim 15, further comprising a compound having at least one radically polymerizable unsaturated bond and dissolved or dispersed in the water.
- 17. (New) The composition as recited in claim 15, wherein said acid-reactive insolubilizing agent is an N-methylolated or N-alkoxymethylated nitrogen-containing compound, a hydroxymethylated phenol derivative or a resol resin.
- 18. (New) The composition as recited in claim 15, wherein said acid-reactive insolubilizing agent is a compound having at least one epoxy group, oxetane group, vinyloxy group, isopropenyloxy group or orthoester group.
- 19. (New) The composition as recited in claim 15, wherein said acid-reactive insolubilizing agent has at least one formyl group.
- 20. (New) The composition as recited in claim 15, further comprising an aqueous emulsion of a hydrophobic polymer.

- 21. (New) The composition as recited in claim 15, further comprising a water-soluble, photo-insolubilizable resin.
- 22. (New) The composition as recited in claim 21, wherein said water-soluble, photo-insolubilizable resin is a photo-crosslinkable polyvinyl alcohol containing a styrylpyridinium group represented by the following formula (1):

wherein R_1 represents a hydrogen atom, an alkyl group or an aralkyl group, R_2 represents a hydrogen atom or a lower alkyl group, X^- represents a halogen ion, a phosphate ion, a p-toluenesulfonate ion or a mixture of these anions, m is a number of 0 or 1 and n is an integer of 1 to 6.

- 23. (New) The composition as recited in claim 21, wherein said water-soluble, photo-insolubilizable resin comprises poly(vinyl alcohol), casein or gelatin, and a water-soluble diazo resin or a dichromate.
- 24. (New) The composition as recited in claim 15, wherein said acid-reactive insolubilizing agent is present in an amount of 5 to 1,000 parts by weight per 100 parts by weight of said water-soluble resin, said acid former is present in an amount of 1 to 100 parts by weight per 100 parts by weight of said acid-reactive insolubilizing agent, and said sensitizer is present in an amount of 5 to 100 parts by weight per 100 parts by weight of said acid former.
- 25. (New) The composition as recited in claim 15, wherein each of said acid former and sensitizer has an average particle diameter of 1.5 μm or less.
- 26. (New) A radiation-sensitive resin film obtained by drying a layer of the composition according to claim 15.
- 27. (New) Use of the resin film of claim 26 for a screen printing process.
- 28. (New) A pattern forming method comprising the steps of:

 irradiating a radiation sensitive resin film according to claim 26 with activation energy, and

developing the irradiated film with water.

- 29. (New) A pattern forming method as recited in claim 28, further comprising heating the irradiated film before said developing with water.
- 30. (New) The composition as recited in claim 15, wherein each of said acid former and sensitizer is in the form of solid particles dispersed in the water.